

ORDERING INFORMATION

Device	Temperature Range	Package
MC1303P	0°C to +75°C	Plastic DIP

MC1303

DUAL STEREO PREAMPLIFIER

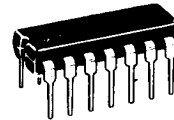
... designed for amplifying low-level stereo audio signals with two preamplifiers built into a single monolithic semiconductor.

Each Preamplifier Features:

- Large Output Voltage Swing -- 4.0 V (RMS) Min
- High Open-Loop Voltage Gain = 6000 min
- Channel Separation = 60 dB min at 10 kHz
- Short-Circuit-Proof Design

DUAL STEREO PREAMPLIFIER INTEGRATED CIRCUIT

SILICON MONOLITHIC INTEGRATED CIRCUIT

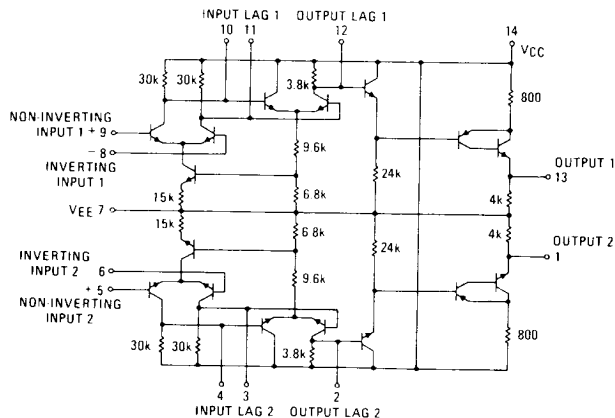


P SUFFIX
PLASTIC PACKAGE
CASE 646

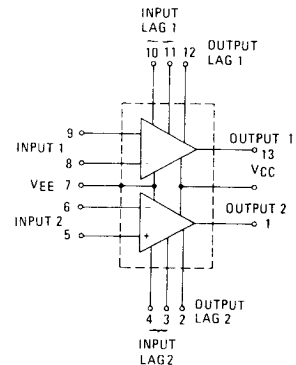
MAXIMUM RATINGS (T_A = +25°C unless otherwise noted.)

Rating	Value	Unit
Power Supply Voltage	+15	Vdc
	-15	
Junction Temperature	+150	°C
Operating Ambient Temperature Range	0 to +75	°C

CIRCUIT SCHEMATIC

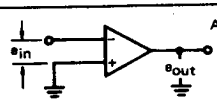

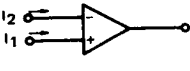
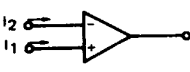
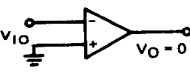
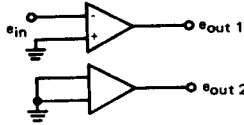


EQUIVALENT CIRCUIT



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ELECTRICAL CHARACTERISTICS (Each Preamplifier) ($V_{CC} = +13$ Vdc, $V_{EE} = -13$ Vdc, $T_A = +25^{\circ}\text{C}$ unless otherwise noted).

Characteristic Definitions (linear operations)	Characteristic	Min	Typ	Max	Unit
 $A_{vol} = \frac{e_{out}}{e_{in}}$	Open Loop Voltage Gain	6,000	10,000	—	V/V
	Output Voltage Swing ($R_L = 10$ kΩ)	4.0	5.5	—	V(RMS)
	Input Bias Current $I_{IB} = \frac{I_1 + I_2}{2}$	—	1.0	10	μA
	Input Offset Current ($I_{IO} = I_1 - I_2$)	—	0.2	0.4	μA
	Input Offset Voltage DC Power Dissipation (Power Supply = ±13 V, $V_O = 0$)	—	1.5	10	mV
	Channel Separation ($f = 10$ kHz)	60	70	—	dB

THERMAL INFORMATION

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature, can be found from the equation:

$$P_D(T_A) = \frac{T_{J(max)} - T_A}{R_{\theta JA}(Typ)}$$

Where: $P_D(T_A)$ = Power Dissipation allowable at a given operating ambient temperature. This must be greater than the sum of the products of the supply voltages and supply currents at the worst case operating condition.

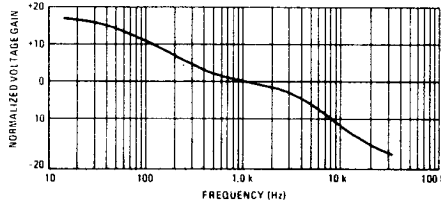
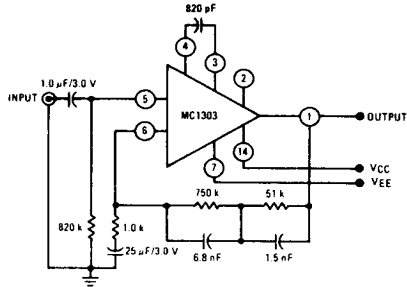
- $T_{J(max)}$ = Maximum Operating Junction Temperature as listed in the Maximum Ratings Section
- T_A = Maximum Desired Operating Ambient Temperature
- $R_{\theta JA}(Typ)$ = Typical Thermal Resistance Junction to Ambient



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TYPICAL PREAMPLIFIER APPLICATIONS

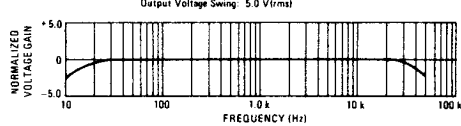
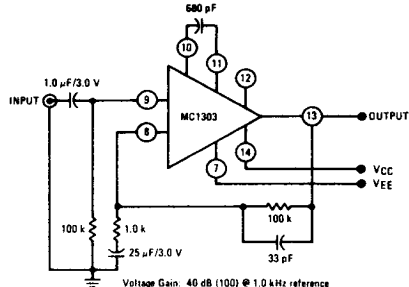
FIGURE 1 - MAGNETIC PHONO PLAYBACK PREAMPLIFIER/RIAA EQUALIZED



TYPICAL PERFORMANCE CHARACTERISTICS
 Voltage Gain: 34 dB (ISO) @ 1.0 kHz
 Input Overload Point: 100 mV RMS @ 1.0 kHz
 Output Voltage Swing: 5.0 V RMS @ 1.0 kHz @ 0.1% THD
 Output Noise Level: Better Than 70 dB Below 10 mV Phono Input (Input Shorted)

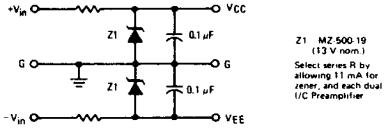
Pins not shown are not connected.

FIGURE 2 - BROAD BAND AUDIO AMPLIFIER



Voltage Gain: 46 dB (100) @ 1.0 kHz reference
 Output Voltage Swing: 5.0 V (rms)

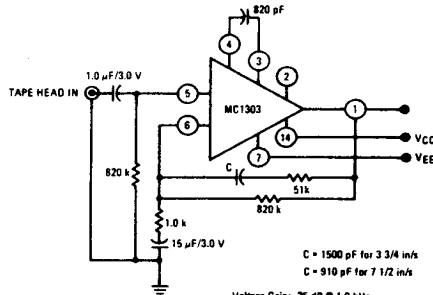
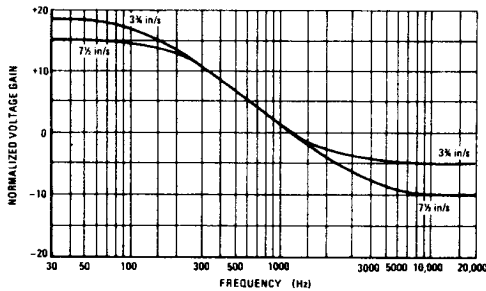
SUGGESTED POWER SUPPLY CIRCUIT



Z1 MZ 500-19 (13 V nom.)
 Select series R by allowing 11 mA for zener, and each dual 1/3 Preamplifier

Pins not shown are not connected.

FIGURE 3 - NAB TAPE HEAD EQUALIZATION



C = 1500 pF for 3 3/4 in/s
 C = 910 pF for 7 1/2 in/s

Voltage Gain: 35 dB @ 1.0 kHz
 Output Voltage Swing: 5.0 V (RMS)

Pins not shown are not connected.

Circuit diagrams utilizing Motorola products are included as a means of illustrating typical semiconductor applications; consequently, complete information sufficient for construction purposes is not necessarily given. The information has been carefully checked and

is believed to be entirely reliable. However, no responsibility is assumed for inaccuracies. Furthermore, such information does not convey to the purchaser of the semiconductor devices described any license under the patent rights of Motorola Inc. or others.

FIGURE 4 – POWER DISSIPATION versus SUPPLY VOLTAGE

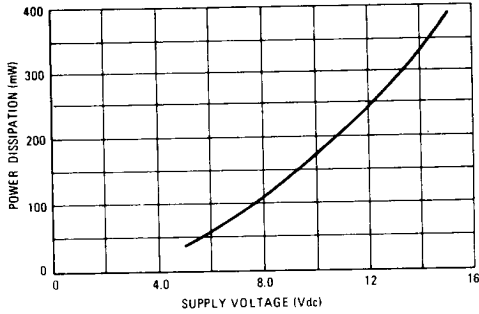


FIGURE 5 – OUTPUT LINEARITY

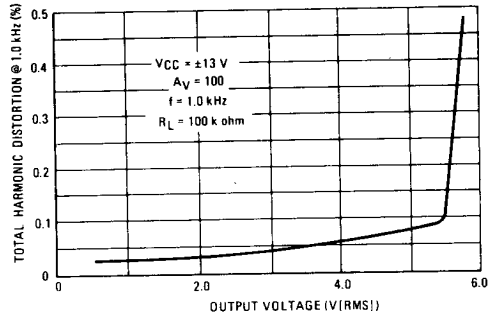
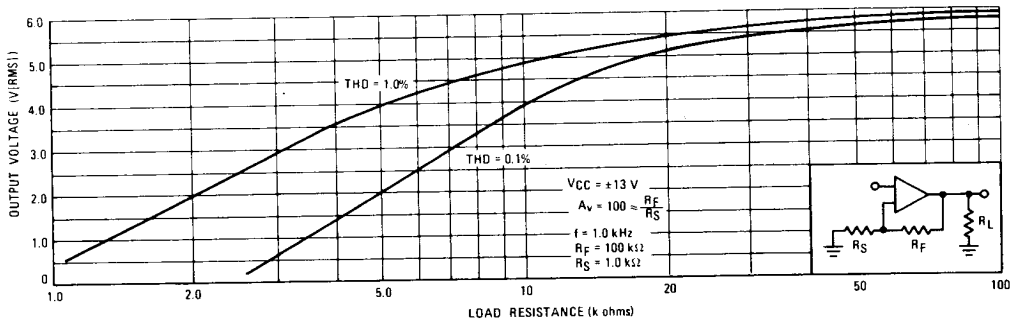


FIGURE 6 – INFLUENCE OF OUTPUT LOADING



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NOISE CHARACTERISTICS

FIGURE 7A – INFLUENCE OF SOURCE RESISTANCE & BANDWIDTH

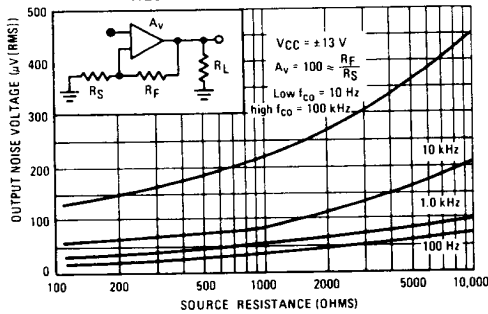
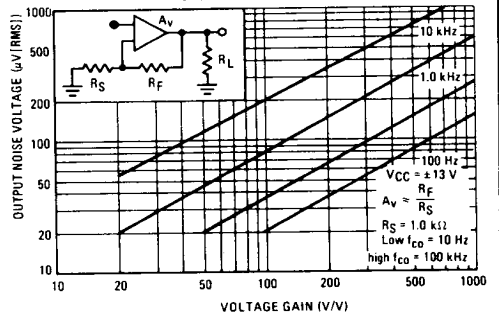


FIGURE 7B – INFLUENCE OF VOLTAGE GAIN & BANDWIDTH



MOTOROLA Semiconductor Products Inc.